

Inductors for Power over Coaxial (PoC)

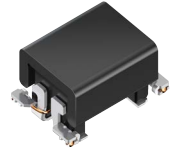
Power injection choke, EIA1210

Series/Type: **ADM32FSC**
Date: October 2022

Rated inductance: 10 ... 22 μ H

Construction

- Metal I-core, Ferrite shielding
- Winding: enamel copper wire
- Winding welded to terminals



Features

- Temperature range up to +165 °C
- Suitable for lead-free reflow soldering as referenced in JEDEC J-STD-020E
- Qualified according to AEC-Q200
- RoHS-compatible

Applications

- Automotive electronics
- Power over Coaxial (PoC)

Terminals

One-sided tinned terminals

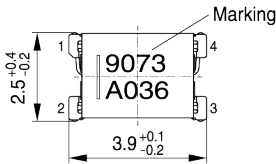
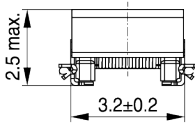
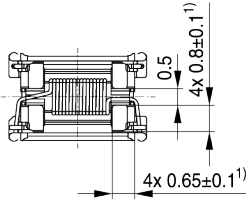
- Base material CuSn6
- Layer composition Ni, Sn
- Lead-free tinned

Marking

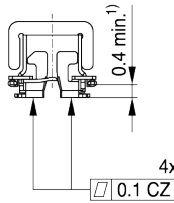
- Marking on component:
L value (in μ H, coded), date code, pin 1 marking
- Minimum data on reel:
Lot number, part number, date of packing

Delivery mode and packing unit

- 12-mm blister tape, wound on 330-mm \varnothing reel
- Packing unit: 6000 pcs./reel

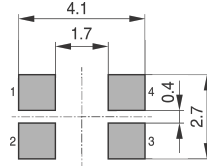
Dimensional drawing


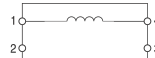
1) Soldering area



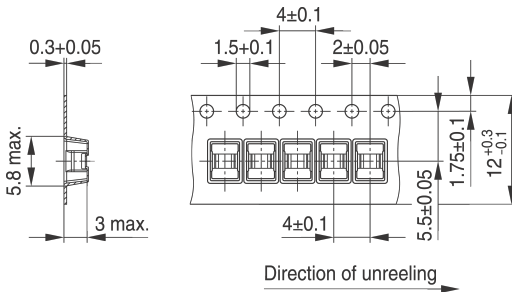
IND2075-I-E

Dimensions in mm

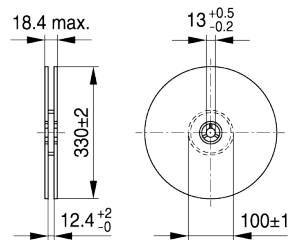
Layout recommendation

 1-2 and 3-4 to be joined in PCB
 IND1749-G-E

Dimensions in mm

 No polarity
 1-2 and 3-4 to be joined in PCB
 IND1750-H-E


IND1751-I

Taping and packing
Blister tape


IND1752-J-E

Reel


IND1526-N

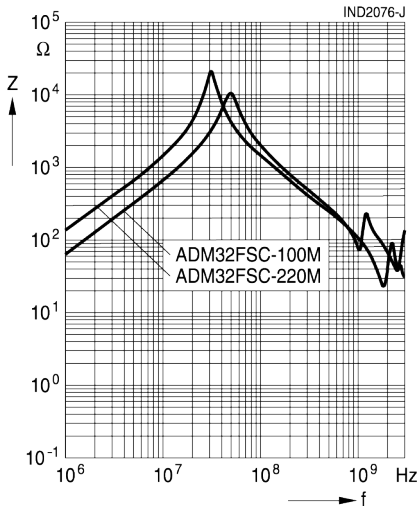
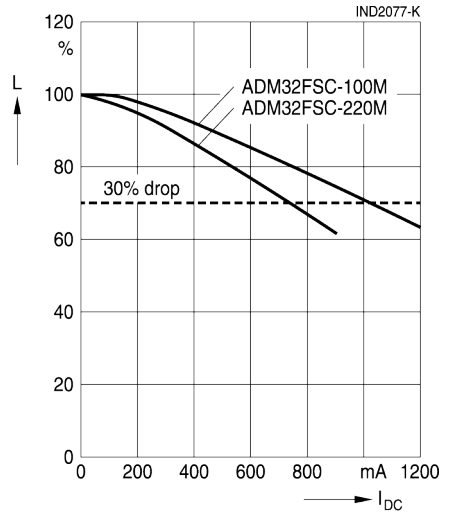
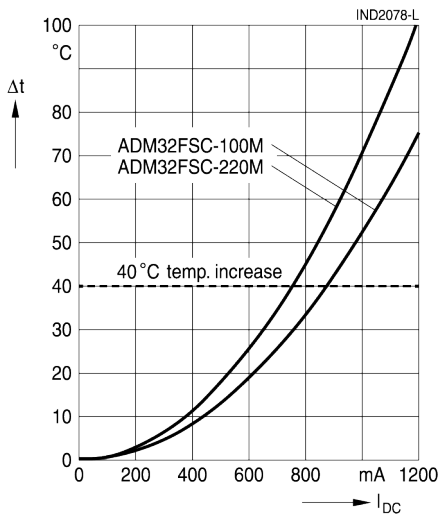
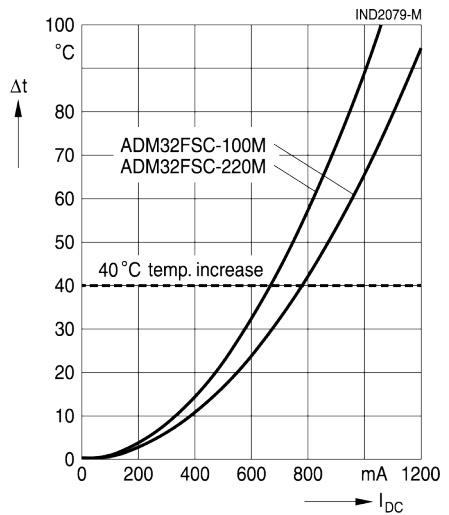
Dimensions in mm

Technical data and measuring conditions

Rated inductance L_R	Measured with Keysight E4980A (or equivalent) at 100 kHz, 0.1 mA, +23 °C \pm 3 °C
Inductance tolerance	\pm 20%
DC resistance R_{DC}	Measured at +23 °C \pm 3 °C
Self-resonant frequency f_{res}	Measured with Keysight E4990A (or equivalent), +23 °C \pm 3 °C
Saturation current I_{sat}	Based on the inductance change rate (30% below the initial value)
Rated current I_{temp}	Based on the temperature increase (+40 °C by self-heating) Ambient temperature: +25 °C / +105 °C / +125 °C I_{temp} are reference values evaluated under consideration of generic multilayer PCB
Weight	Approx. 0.08 g

Characteristics and ordering codes

L_R μ H	R_{DC} Ω max.	f_{res} MHz typ.	$I_{sat,typ}$ mA @ Ambient temp. +25 °C	$I_{temp,typ}$ mA @ Ambient temp. + temp. increase in (°C)			Internal code	Ordering code
				+25+40	+105+40	+125+40		
10	0.42	52	1060	880	790	770	B82782N1103H100	ADM32FSC-100M
22	0.60	33	740	740	680	660	B82782N1223H100	ADM32FSC-220M

Impedance versus frequency (typical curves)

Saturation current I_{sat} (typical curves)

Rated current I_{temp} (typical curves at ambient temp. +25 °C)

Rated current I_{temp} (typical curves at ambient temp. +125 °C)


Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation. Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire, wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequency behaviour of the components.
 - Many coating materials have a negative effect (chemically and mechanically) on the winding wires, insulation materials and connecting points. Customers are always obligated to determine whether and to what extent their coating materials influence the component. Customers are responsible and bear all risk for the use of the coating material. TDK Electronics does not assume any liability for failures of our components that are caused by the coating material.
- Ceramics / ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

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3. **The warnings, cautions and product-specific notes must be observed.**
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Important notes

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Release 2022-07